SPEC. No. ED-03P004 ISSUE July 1, 2003

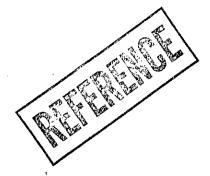
OPTO-ELECTRONIC DEVICES DIVISION ELECTRONIC COMPONENTS GROUP SHARP CORPORATION

DEVICE SPECIFI	CATION FOR	₹	
	PHOT	OCOUPLER	
MODEL No.			
	.]	PC817	
	Bus	iness dealing name	
		PC817XNNSZW	
		PC817X1NSZW	
		PC817X2NSZW	
		PC817X3NSZW	
		PC817X5NSZW	
		PC817X6NSZW	
		PC817X8NSZW	

Specified for	
Enclosed please find copies of the Specification After confirmation of the contents, please be sure with approving signature on each.	ns which consists of 11 pages including cover. are to send back copies of the Specifications
CUSTOMER'S APPROVAL	PRESENTED
DATE	DATE
ВУ	BY K.H
	K. Hachimura, Department General Manager of Engineering Dept.,II Onto-Electronic Devices Div.

ELECOM Group SHARP CORPORATION Product name

PHOTOCOUPLER



Model No.: PC817

Business dealing name

PC817XNNSZW
PC817X1NSZW
PC817X2NSZW
PC817X3NSZW
PC817X5NSZW
PC817X6NSZW
PC817X8NSZW

- These specification sheets include materials protected under copyright of Sharp Corporation ("Sharp").
 Please do not reproduce or cause anyone to reproduce them without Sharp's consent.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets, and the precautions mentioned below.

(Precautions)

- (1) This product is designed for use in the following application areas;
 - OA equipment Audio visual equipment · Home appliances
 - · Telecommunication equipment (Terminal) · Measuring equipment
 - Tooling machines Computers

 If the use of the product in the above application areas is for equipment listed in paragraphs

(2) or (3), please be sure to observe the precautions given in those respective paragraphs.

- (2) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as;
 - · Transportation control and safety equipment (aircraft, train, automobile etc.)
 - · Traffic signals · Gas leakage sensor breakers · Rescue and security equipment
 - Other safety equipment etc.
- (3) Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as;
 - Space equipment Telecommunication equipment (for trunk lines)
 Nuclear power control equipment Medical equipment etc.
- (4) Please contact and consult with a Sharp sales representative if there are any questions regarding interpretation of the above three paragraphs.
- Please contact and consult with a Sharp sales representative for any questions about this product.

1. Application

This specification applies to the outline and characteristics of photocoupler Model No. PC817series.

2. Outline

Refer to the attached sheet, page 3.

3. Ratings and characteristics

Refer to the attached sheet, page 4, 5.

4. Reliability

Refer to the attached sheet, page 6.

5. Outgoing inspection

Refer to the attached sheet, page 7.

6. Supplement

6.1 Isolation voltage shall be measured in the following method.

- (1) Short between anode to cathode on the primary side and between collector to emitter on the secondary side.
- (2) The dielectric withstand tester with zero-cross circuit shall be used.
- (3) The wave form of applied voltage shall be a sine wave.(It is recommended that the isolation voltage be measured in insulation oil.)

6.2 Package specifications

Refer to the attached sheet, page 8, 9.

6.3 Business dealing name

("O" mark indicates business dealing name of ordered product)

Ordered product	Business dealing name	Rank mark	Ic (mA)
	PC817XNNSZW	A, B, C, or no mark	2.5 to 30
· .	PC817X1NSZW	A	4.0 to 8.0
<u> </u>	PC817X2NSZW	В	6.5 to 13
	PC817X3NSZW	С	10 to 20
	PC817X5NSZW	A or B	4.0 to 13
	PC817X6NSZW	B or C	6.5 to 20
-	PC817X8NSZW	A, B or C	4.0 to 20

r	Test conditions
	I _F =5mA V _{CE} =5V Ta=25°C

- 6.4 This Model is under application by UL.
- 6.5 This product is not designed against irradiation.

This product is assembled with electrical input and output.

This product incorporates non-coherent light emitting diode.

6.6 ODS materials

This product shall not contain the following materials.

Also, the following materials shall not be used in the production process for this product.

Materials for ODS : CFC₈, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform)

6.7 Brominated flame retardants

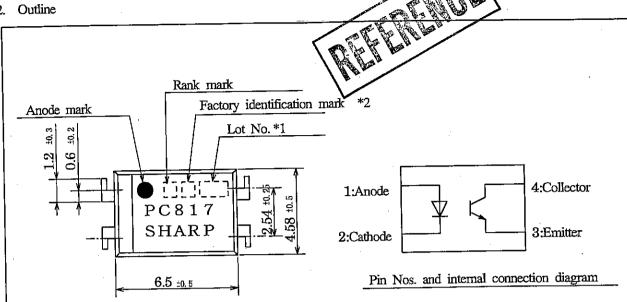
Specific brominated flame retardants such as the PBBOs and PBBs are not used in this device at all.

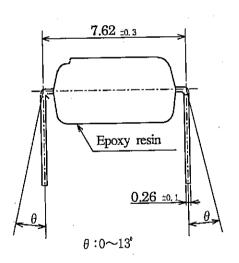
7. Notes

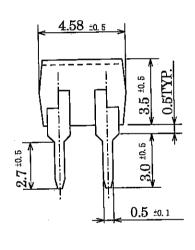
Precautions for Photocouplers

Refer to the attachment-1.







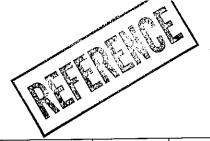


Product mass: Approx. 0.21g

- *1) 2-digit number shall be marked according to DIN standard.
- Factory identification mark shall be or shall not be marked.
- Marking is laser marking
- Pin material: Copper Alloy

Pin finish: Pd plating

,	UNIT: 1/1 mm
Name	PC817 Outline Dimensions (Business dealing name: PC817XNNSZW)



3. Ratings and characteristics

3.1 Absolute maximum ratings

Ta=25°C

		Parameter	Symbol	Rating	Unit
	*1	Forward current	$I_{\rm F}$	50	mA
1	*2	Peak forward current	I_{FM}	1	Α
Input	_	Reverse voltage	V _R	6	V
ļ	*1	Power dissipation	P	70	mW
		Collector-emitter voltage	V _{CEO}	80	V
-		Emitter-collector voltage	V _{ECO}	6	V
Output		Collector current	Ic	50	mA
	*1	Collector power dissipation	Pc	150	mW
	*1	Total power dissipation	Ptot	200	mW
	·	Operating temperature	Topr	-30 to +100	°C
<u>`</u>		Storage temperature	Tstg	-55 to +125	℃
	*3	Isolation voltage	Viso(rms)	5	kV
	*4	Soldering temperature	Tsol	270	$^{\circ}$

- *1 The derating factors of absolute maximum ratings due to ambient temperature are shown in Fig. 1 to 4.
- *2 Pulse width $\leq 100 \,\mu$ s, Duty ratio : 0.001 (Refer to Fig. 5)
- *3 AC for 1 min, 40 to 60%RH
- *4 For 10 s

3.2 Electro-optical characteristics

Ta=25°C

Parameter		Symbol	Condition	MIN.	TYP.	MAX.	Unit
<u> </u>	Forward voltage	V _F	I _F =20mA	-	1.2	1.4	V
Input	Peak forward voltage	V _{FM}	I _{FM} =0.5A	-	-	3.0	V
	Reverse current	I_R	V _R =4V	-	-	10	μА
	Terminal capacitance	Ct	V=0, f=1kHz	-	30	250	pF
	Dark current	I _{CEO}	V _{CE} =50V, I _r =0	_	-	100	nА
Output	Collector-emitter breakdown voltage	BV _{CEO}	Ic=0.1mA I _F =0	80	-	-	V
	Emitter-collector breakdown voltage	BV _{ECO}	I _E =10 μ A, I _F =0	6	-	-	V
	Collector current	Ic	I _F =5mA, V _{CE} =5V	2.5	-	30	mA
	Collector-emitter saturation voltage	V _{CE(sat)}	I _F =20mA Ic=1mA	-	0.1	0.2	V
	Isolation resistance	R _{ISO}	DC500V 40 to 60%RH	5×10 ¹⁰	1011	-	Ω
Transfer charac- teristics	Floating capacitance	Cf	V=0, f=1MHz	-	0.6	1.0	pF
	Cut-off frequency	fc	V_{CE} =5V, Ic=2mA R ₁ =100 Ω , -3dB	-	80	_	kHz
	Rise time	tr	V _{CE} =2V Ic=2mA	_	4	18	μs
	Fall time	tf	R _L =100 Ω	-	3	18	μS

(Fig. 1) Forward

Forward current vs. ambient temperature

50

40

11

20

30

0

25

55

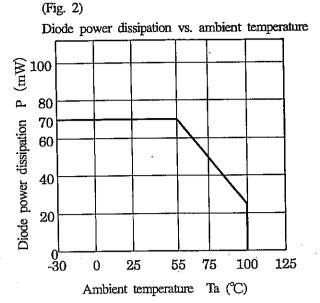
75

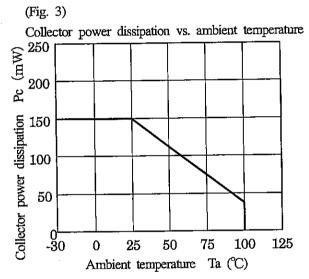
100

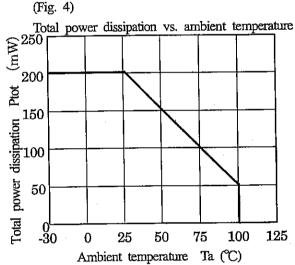
125

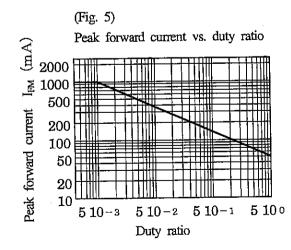
Ambient temperature

Ta (°C)









Pulse width $\leq 100 \mu s$ Ta = 25°C



4. Reliability

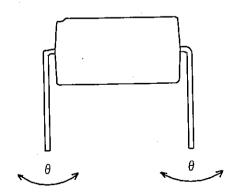
The reliability of products shall satisfy items listed below.

Confidence level: 90%

LTPD: 10 or 20

Test Items	Condition	Failure Judgement Criteria	Samples (n) Defective (C)
Solderability *2	245±3°C, 3s	245±3°C, 3s	
	(Flow soldering) 270°C, 10 s		n=11, C=0
Soldering heat	(Soldering by hand) 400°C, 3 s		
Terminal strength (Tension)	Weight: 5N 5 s/each terminal	$V_F > U \times 1.2$ $I_R > U \times 2$	n=11, C=0
Terminal strength (Bending) *3	Weight: 2.5N 2 times/each terminal	I _{CEO} >U×2 I _C <l×0.7< td=""><td>n=11, C=0</td></l×0.7<>	n=11, C=0
Mechanical shock	15km/s ² , 0.5ms 3 times/±X, ±Y, ±Z direction	V _{CE(sat)} >U×1.2	n=11, C=0
Variable frequency	100 to 2000 to 100Hz/4 min 200m/s ² 4 times/X, Y, Z direction		n=11, C=0
Temperature cycling	1 cycle _55 °C to +125 °C (30 min) (30 min) 20 cycles test	U: Upper specification limit	n=22, C=0
High temp. and high Humidity storage	+60, 90H, 1000h	L: Lower specification limit	
High temp. storage	+125 ℃, 1000h		n=22, C=0
Low temp. storage	-55 ℃, 1000h		n=22, C=0
Operation life	I _F =50mA, Ptot=200mW Ta=25 °C, 1000h		n=22, C=0

- *1 Test method, conforms to EIAJ ED 4701.
- *2 Solder shall adhere at the area of 95% or more of immersed portion of lead, and pin hole or other holes shall not be concentrated on one portion.
- *3 Terminal bending direction is shown below.





- 5. Outgoing inspection
 - 5.1 Inspection items
 - (1) Electrical characteristics

 $V_{F}, I_{R}, I_{CEO}, V_{CE(sat)}, Ic, R_{ISO}, Viso$

- (2) Appearance
- 5.2 Sampling method and Inspection levelA single sampling plan, normal inspection level II based on ISO 2859 is applied.

The AQL according to the inspection items are shown below.

Defect	Inspection item	AQL(%)
Major defect	Major defect Electrical characteristics Unreadable marking	
Minor defect	defect Appearance defect except the above mentioned.	



6.2 Package specification

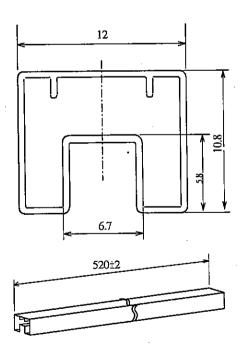
6.2.1 Package materials

No.	Name	Materials	Purposes
1	Sleeve	HIPS with preventing static electricity	Products packaged
2	Stopper	Styrene-Elastomer	Products fixed
3	Packing case	Corrugated cardboard	Sleeve packaged
4	Kraft tape	Paper	Lid of packaged case fixed
5	Label	Paper	Model No., quantity, inspection date and lot No. specified

6.2.2 Package method

- (1) MAX. 100pcs. of products shall be packaged in a sleeve and both of sleeve edges shall be fixed by stoppers.
- (2) MAX. 20 sleeves above shall be packaged in a packing case and pack a sheet of cushion at one side.
- (3) Model No., quantity, inspection date and lot No. shall be marked on the label and this label shall be put on the side of the packaging case.
- (4) Case shall be closed with the lid and enclosed with kraft tape.

6.2.3 Sleeve outline dimensions



Note 1) Thickness: 0.5 ± 0.2 mm

2) Outer R: 0.5mm

- 3) Process with applying antistatic treatment.
- Unless otherwise specified tolerances shall be ±0.5mm.
 (However except for deformation due to the rubber stopper in sleeve.)

9/9

Regular packing mass: Approx. 860g

(): TYP. value

(65mm)

(540mm)



Precautions for Photocouplers

Solvent temperature 45°C or less

Immersion for 3 min or less

Ultrasonic cleaning: The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power

output, cleaning time, PCB size or device mounting condition etc.

Please test it in actual using condition and confirm that doesn't occur any defect before starting

the ultrasonic cleaning.

Applicable solvent: Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

In case when the other solvent is used, there are cases that the packaging resin is eroded.

Please use the other solvent after thorough confirmation is performed in actual using condition.

The LED used in the Photocoupler generally decreases the light emission power by operation. 2. In case of long operation time, please design the circuit with considering the degradation of the light emission power of the LED. (50%/5 years)

There are cases that the deviation of the CTR and the degradation of the light emission power 3. of the LED become big at IF is less than 1.0mA. Please design the circuit with considering this point.

Precautions for Soldering

(1) In case of flow solder (Whole dipping is possible) It is recommended that flow solder should be at 270°C and within 10 seconds (Pre-heating: 100 to 150°C, 30 to 80 seconds)

It is recommended that hand soldering should be within 390±10°C and within 3 seconds: Within 2 times

(3) Other notes

Depend on equipment and soldering conditions (temperature, Using solder etc.), the effect to junction between PCB and lead pins of photocoupler is different. Please confirm that there is no problem on the actual use conditions.

单击下面可查看定价,库存,交付和生命周期等信息

>>SHARP